

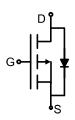
Feature

-20V,-3A

$$\begin{split} &R_{DS\;(ON)}\, <\!75m\,\Omega\,@V_{GS}\!\!=\!\!-4.5V \quad TYP:\!57m\,\Omega \\ &R_{DS\;(ON)}\, <\!95m\,\Omega\,@V_{GS}\!\!=\!\!-2.5V \quad TYP:\!74\;m\,\Omega \end{split}$$

Advanced Trench Technology

Lead free product is acquired



Schematic diagram

Application

- Interfacing Switching
- Load Switching
- Power management



SOT-23 top view

Package Marking and Ordering Information

Devic	e Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
	2301	AP2301	SOT-23	7 inch	-	3000

ABSOLUTE MAXIMUM RATINGS (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	-20	V
Gate-Source Voltage	V _{GS}	±12	V
Continuous Drain Current (T _a =25℃)	ΙD	-3	Α
Continuous Drain Current (T _a =70℃)	ID	-2	Α
Pulsed Drain Current	I _{DM}	-12	А
Power Dissipation	P _D	1	W
Thermal Resistance from Junction to Ambient ⁽⁴⁾	R _{θJA}	125	°C/W
Junction Temperature	TJ	150	$^{\circ}$ C
Storage Temperature	T _{STG}	-55~ +150	$^{\circ}$



MOSFET ELECTRICAL CHARACTERISTICS(T_J=25℃ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Туре	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =-250μA	-20	-	-	V
Zero gate voltage drain current	IDSS	V _{DS} =-20V, V _{GS} = 0V	-	-	1	μA
Gate-body leakage current	lgss	V _{GS} =±12V,V _{DS} = 0V	-	_	±100	nA
Gate threshold voltage ⁽³⁾	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-0.5	-0.7	-1.0	V
Drain-source on-resistance ⁽³⁾	Б	V _{GS} =-4.5V, I _D =-3A	-	57	75	- mΩ
Drain-source on-resistance	R _{DS(on)}	V _{GS} =-2.5V, I _D =-2A	-	74	95	
Dynamic characteristics						
Input Capacitance	Ciss		-	503	-	pF
Output Capacitance	Coss	V _{DS} =-10V, V _{GS} =0V, f =1MHz	_	67	-	
Reverse Transfer Capacitance	C _{rss}	_	_	58	-	
Switching characteristics						
Turn-on delay time	t _{d(on)}		-	11	_	
Turn-on rise time	t _r	V _{DD} =-10V, I _D =-3A,	_	52	-	ns
Turn-off delay time	t _{d(off)}	V_{GS} =-4.5V, R_G =3 Ω	_	16	-	
Turn-off fall time	tf	_	-	10	-	
Total Gate Charge	Qg	\/D0_40\/_ID_04	-	4.1	-	
Gate-Source Charge	Qgs	VDS=-10V, ID=-2A,	-	0.8	-	nC
Gate-Drain Charge	Qgd	- VGS=-4.5V	-	1.1	-	
Source-Drain Diode characteristics	•	•	•	•		
Diode Forward voltage ⁽³⁾	V _{DS}	V _{GS} =0V, I _S =-3A	_	-	1.2	V
Diode Forward current ⁽⁴⁾	Is		-	-	-3	Α

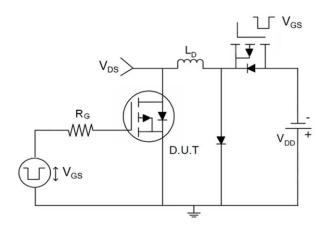
Notes:

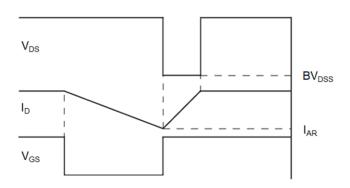
- 1. Repetitive Rating: pulse width limited by maximum junction temperature
- 2. Pulse Test: pulse width≤300µs, duty cycle≤2%
- 3. Surface Mounted on FR4 Board,t≤10 sec



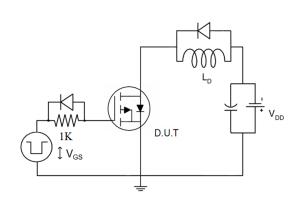
Test Circuit

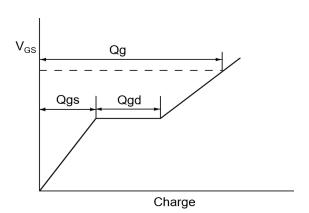
1) E_{AS} Test Circuits



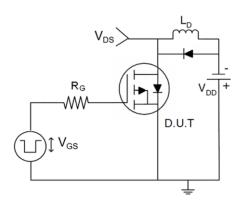


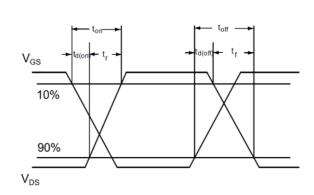
2) Gate Charge Test Circuit





3) Switch Time Test Circuit







Typical Performance Characteristics

Figure1: Output Characteristics

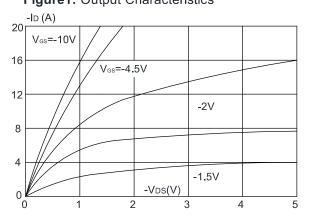


Figure 3:On-resistance vs. Drain Current

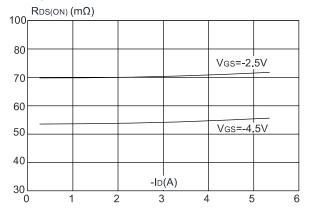


Figure 5: Gate Charge Characteristics

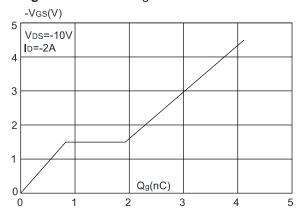


Figure 2: Typical Transfer Characteristics

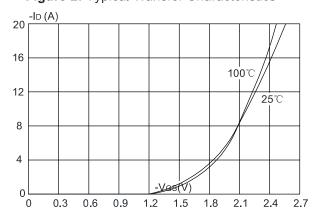


Figure 4: Body Diode Characteristics

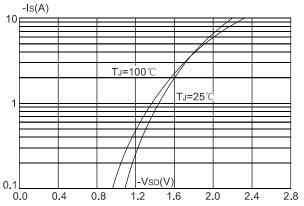
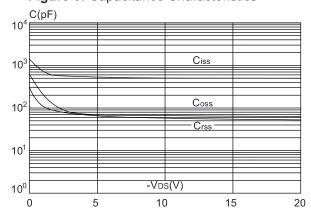


Figure 6: Capacitance Characteristics





DATA SHEET

Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

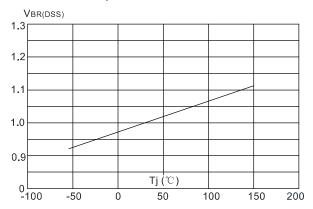


Figure 9: Maximum Safe Operating Area

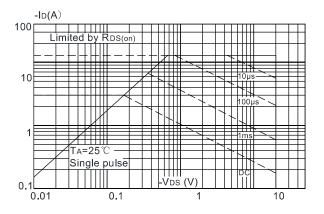


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

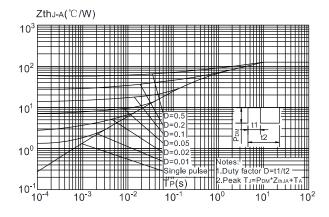


Figure 8: Normalized on Resistance vs. Junction Temperature

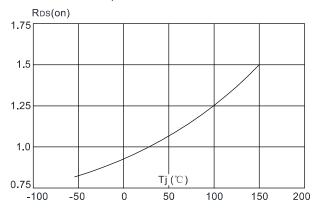
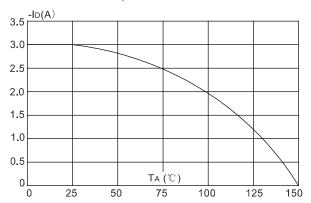
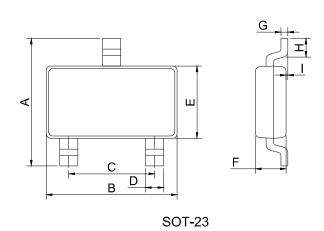


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature



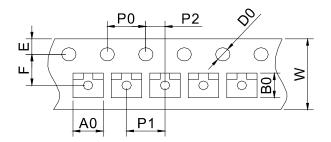


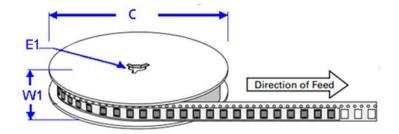
SOT-23 Package Information



	Dimensions					
Ref.	N	1illimete	rs	Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.30	2.40	2.50	0.091	0.095	0.098
В	2.80	2.90	3.00	0.110	0.114	0.118
С	1.90 REF			0.075 REF		
D	0.35	0.40	0.45	0.014	0.016	0.018
Е	1.20	1.30	1.40	0.047	0.051	0.055
F	0.90	1.00	1.10	0.035	0.039	0.043
G		0.10	0.15		0.004	0.006
Н	0.20			0.008		
ı	0		0.10	0		0.004

Package Information-SOT-23





Def	Dimensions				
Ref.	Millimeters	Inches			
A0	3.15 ± 0.3	0.124 ± 0.012			
В0	2.77 ± 0.3	0.109 ± 0.012			
С	178	7.0			
D0	1.50±0.1	0.059 ± 0.004			
E	1.75 ± 0.2	0.069 ± 0.008			
E1	13.3±0.3	0.524± 0.012			
F	3.5 ± 0.2	0.138 ± 0.008			
P0	4.00 ± 0.2	0.157 ± 0.008			
P1	4.00 ± 0.2	0.157 ± 0.008			
P2	2.00 ± 0.2	0.079 ± 0.008			
W	8.00 ± 0.2	0.315 ± 0.008			
W1	11.5±1.0	0.453 ± 0.039			

AP2301





Revision History

Revision	Release	Remark
V1.0	2023/04/10	Initial Release

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Allpower assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.

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